

09/800, 483

L Number	Hits	Search Text	DB	Time stamp
1	298	(385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$	USPAT	2004/08/10 14:32
2	471	(385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:32
3	299	((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:33
5	197	((((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)) and pin\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:36
6	93	(((((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)) and pin\$1) and resin\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:36
7	78	((((((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)) and pin\$1) and resin\$1) and hole\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:37
9	1	((((((((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)) and pin\$1) and resin\$1) and hole\$1) and expose\$1) and (planar ADJ surface\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:39
8	40	((((((((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)) and pin\$1) and resin\$1) and hole\$1) and expose\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:41
10	37	((((((((385/92.cor. or 385/49.cor. or 385/88.cor.) and mold\$) and (wire\$ or conductor\$)) and pin\$1) and resin\$1) and hole\$1) and expose\$1) and (optic\$ ADJ fiber\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:42